

# Linux Interface Specification Device Driver GPT

User's Manual: Software

RZ/G2L Group, RZ/V2L Group,  
RZ/G3E Group and RZ/Five

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The following usage notes are applicable to all Micro processing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

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A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

### 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

### 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

### 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

### 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

### 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

### 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

### 8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a micro processing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

# How to Use This Manual

## 1. Purpose and Target Readers

This manual is designed to provide the user with an understanding of the hardware functions and electrical characteristics of the MPU. It is intended for users designing application systems incorporating the MPU. It is intended for users developing software incorporating the processors. A basic knowledge of software development and Linux systems is necessary in order to use this document.

Particular attention should be paid to the precautionary notes when using the manual. These notes occur within the body of the text, at the end of each section, and in the Usage Notes section.

The revision history summarizes the locations of revisions and additions. It does not list all revisions. Refer to the text of the manual for details.

The following documents apply to the RZ/G2L Group, RZ/V2L Group and RZ/G3E Group. Make sure to refer to the latest versions of these documents. The newest versions of the documents listed may be obtained from the Renesas Electronics Web site.

Document Type	Description	Document Title	Document No.
User's manual for Hardware	Hardware specifications (pin assignments, memory maps, peripheral function specifications, electrical characteristics, timing charts) and operation description  Note: Refer to the application notes for details on using peripheral functions.	RZ/G2L Group User's Manual: Hardware	---
		RZ/V2L Group User's Manual: Hardware	---
		RZ/G3E Group User's Manual: Hardware	---
User's manual for Software	Software specifications (basic function of Linux kernel, memory maps, interrupt, clock, pins mux, device tree)	Linux interface Specification - Device Driver GPT	This User's manual
Application Note	Information on using peripheral functions and application examples Sample programs Information on writing programs in assembly language and C	Available from Renesas Electronics Web site.	
Renesas Technical Update	Product specifications, updates on documents, etc.		

2. Notation of Numbers and Symbols

3. Register Notation

#### 4. List of Abbreviations and Acronyms

Abbreviation	Full Form
Hi-Z	High Impedance
I/O	Input/Output
LSB	Least Significant Bit
MSB	Most Significant Bit
PLL	Phase Locked Loop
PWM	Pulse Width Modulation

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# 1. Overview

## 1.1 Overview

This manual explains the driver module (this module) that controls the GPT timer on RZ/G2L Group, RZ/V2L Group and RZ/G3E. Detailed explanation is skipped because the interface of this module is based on Linux. Note: Currently, the devices that support this function are RZ/G2L, RZ/G2LC, RZ/V2L. RZ/G2UL does not have the GPT module.

Note: Currently, this device is supported in two kernel versions v5.10 and v6.1 with the information below:

- v5.10: RZ/G2L Group, RZ/V2L group and RZ/Five.
- v6.1: RZ/G2L, RZ/G2LC and RZ/G3E.

## 1.2 Function

This module controls the GPT timer on RZ/G2L Group, RZ/V2L Group and RZ/G3E Group. The following functionality is supported:

- Output continuous high-level width of signal.
- Single buffer output operation.
- Double buffer output operation.
- Dead time output operation.
- Input capture operation.
- Counting input operation.
- The settable range of periods is from 30ns to 2.15 seconds. This limitation is due to sysfs framework.
- The settable range of duty cycles is from 30ns to the value of period.
- Change polarity and idle state.
- Double output on single channel.
- Output pulse number can be specified.
- Port Output Enable for GPT (This function can enable via sysfs)
  1. Disable output via software.
  2. Disable output via input level detection.
  3. Disable output request from GPT.
  4. POEG pin can be used to reset counter when GPT operates in counting input.

Note: RZ/G3E currently supports 3 modes:

- Output continuous high-level width of signal.
- Single buffer output operation.
- Double buffer output operation.



### 1.3 Connected Port

The supported connector of this module is as follows.

**Table 1.1 Supported connector.**

Channel	Connector	Support status	Remark
GPT 0	-	No	-
GPT 1	-	No	-
GPT 2	-	No	-
GPT 3	-	No	-
GPT 4	SMARC module: CN4 Carrier board: J1	Yes	Output as PMOD0_PIN7 (channel A) PMOD0_PIN10 (channel B)
GPT 5	-	No	-
GPT 6	-	No	-
GPT 7	-	No	-
POEGA	-	No	-
POEGB	-	No	-
POEGC	-	No	-
POEGD	-	No	-

**Table 1.2 Supported connector (RZ/G3E).**

Channel	Connector	Support status	Remark
GPT0_0	-		
GPT0_1	-	Yes	Output as PMOD1_A6_PIN3(channel A) and PMOD1_A6_PIN4(channel B)
GPT0_2	-		
GPT0_3	-		
GPT0_4	-		
GPT0_5	-		
GPT0_6	-		
GPT0_7	-		
GPT1_0	-		
GPT1_1	-		
GPT1_2	-		
GPT1_3	-		
GPT1_4	-		
GPT1_5	-		
GPT1_6	-		
GPT1_7	-		
POEGA	-	Yes	
POEGB	-		
POEGC	-		
POEGD	-		

## **1.4 Reference**

### **1.4.1 Standard**

There is no supported standard in this module.

### **1.4.2 Related document**

There is no related document.

## **1.5 Restrictions**

There are no restrictions.

## 2. Terminology

The following table shows the terminology related to this module.

**Table 2.1 Terminology**

Terms	Explanation
PWM	Pulse width modulation
GPT	General PWM Timer
LVDS	Low voltage differential signaling
BKLT	Back light
POEG	Port Output Enable for GPT

## 3. Operating Environment

### 3.1 Hardware Environment

The following table lists the hardware needed to use this module.

**Table 3.1 Hardware Environment**

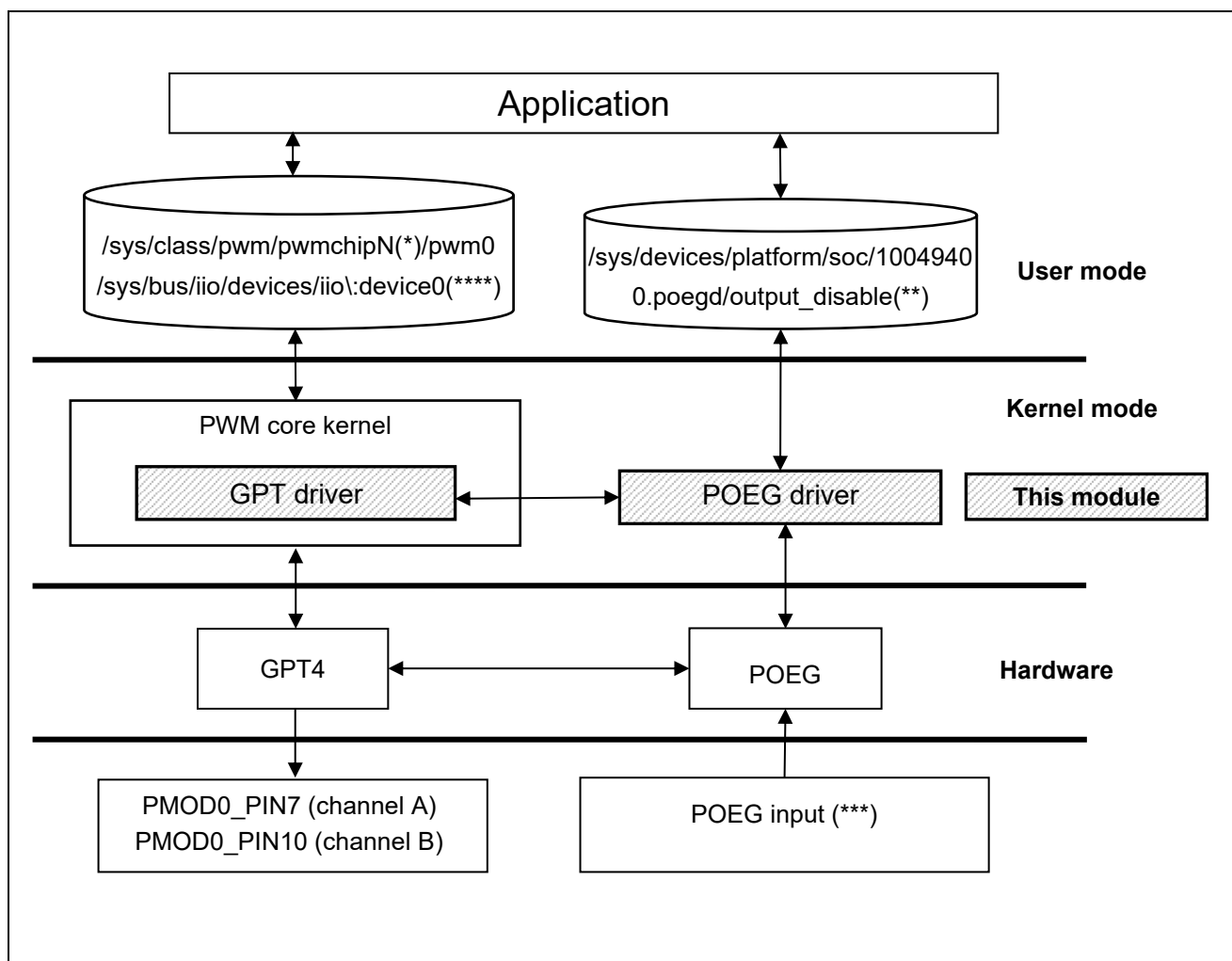
Name	Version	Manufacturer
RZ/G2L Evaluation Board Kit	SMARC module: v01 Carrier board: v04	Renesas Electronics Europe GmbH
RZ/G2LC Evaluation Board Kit	SMARC module: v01 Carrier board: v04	Renesas Electronics Europe GmbH
RZ/V2L Evaluation Board Kit	SMARC module: v01 Carrier board: v04	Renesas Electronics Europe GmbH

**Table 3.2 Hardware Environment (RZ/G3E)**

Name	Product number
RZ/G3E SMARC Evaluation Board Kit.	RTK9947E57S01000BE

## 3.2 Module Configuration

The following figure shows the configuration of this module.



**Figure 3-1 Module configuration (RZ/G2L, RZ/G2LC, RZ/V2L)**

Note: (\*) Each probed PWM controller/chip will be exported as `pwmchipN`, where N is the base of the PWM chip.

(\*\*) Setting to this device sysfs depends on which POEG user is using. In this case, POEGD is using, user can see others poeg and address if others poeg is used.

(\*\*\*) RZ/G2L Evaluation Board Kit don't have input pin for POEG.

(\*\*\*\*) When enable without others iio device, `/sys/bus/iio/devices/iio\:deviceX` is device0, when enable with other iio device (like MTU), it is device1, user should check whether it is iio device for GPT, as picture it is enable without others device.

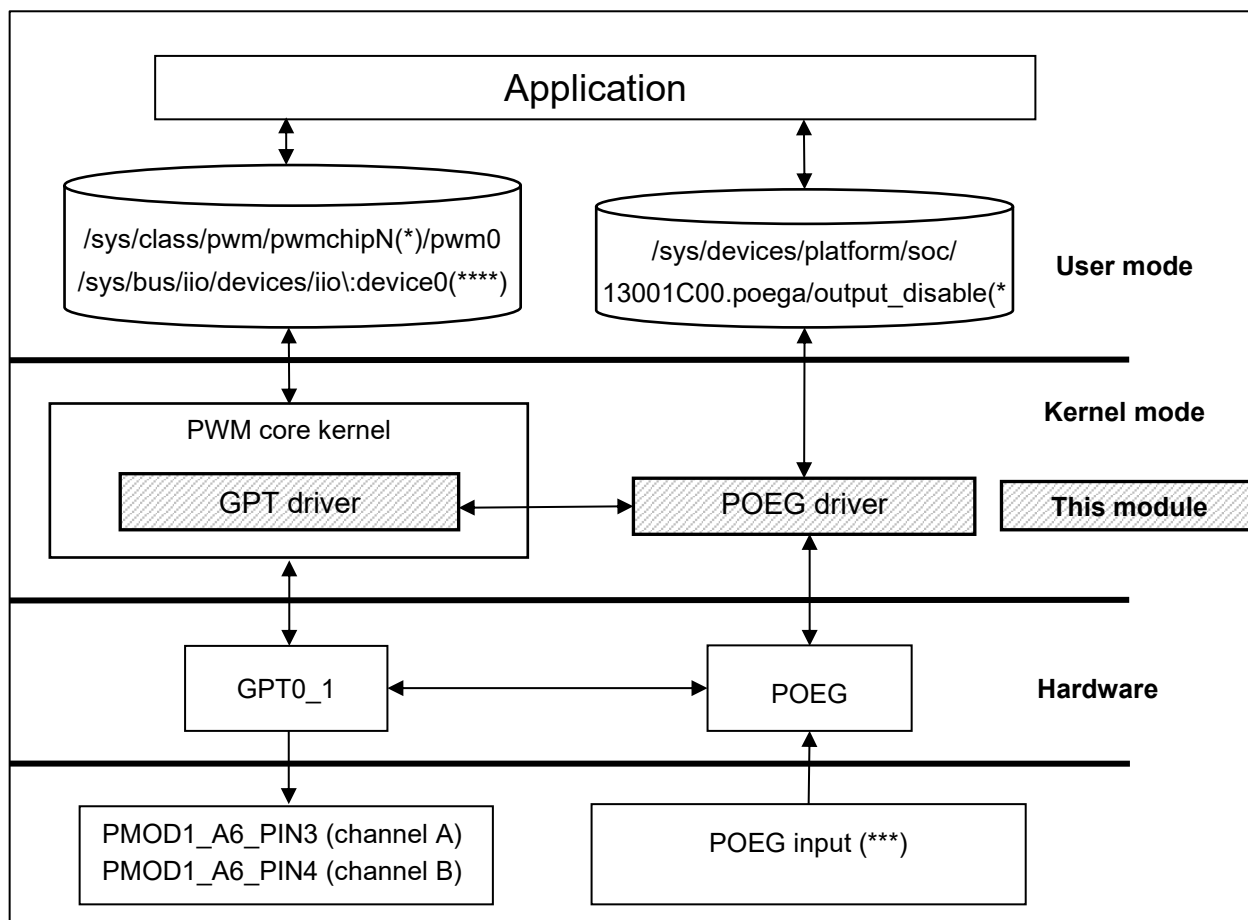


Figure 3-2 Module configuration RZ/G3E

## 4. External Interface

This section explains in the following format about the functions this module supplies.

### 4.1 sysfs interface

The external interface of this module is based on Linux. The interface for operating GPT from a user space is PWM sysfs for PWM operation and IIO sysfs for counting operation. Device node of this module is shown below.

**Table 4.1 GPT device file**

GPT	Device Node
GPT	/sys/class/pwm/pwmchip0/pwm0 /sys/bus/iio/devices/iio\:device0 (*)

The interface for operating POEG from a user space is created in sysfs. Device node of this module is shown below. Use this device node to control POEG via software.

(\*) When enable without others iio device, /sys/bus/iio/devices/iio\:deviceX is device0, when enable with other iio device (like MTU), it is device1, user should check whether it is iio device for GPT, as picture it is enable without others device.

**Table 4.2 POEG device file**

POEG	Device Node
POEGA	/sys/devices/platform/soc/10048800.poega/output_disable
POEGB	/sys/devices/platform/soc/10048c00.poeqb/output_disable
POEGC	/sys/devices/platform/soc/10049000.poegc/output_disable
POEGD	/sys/devices/platform/soc/10049400.poegd/output_disable

The GPT sub-system provides a number of controls that can be accessed via /sys/class/pwm and /sys/bus/iio/devices.

**Table 4.3** shows GPT specification in RZ/G2L. If you want to confirm the other interface, please see: <https://www.kernel.org/doc/Documentation/ABI/testing/sysfs-class-pwm>

**Table 4.4** shows POEG specification in RZ/G2L

**Table 4.3 GPT sysfs device file**

GPT Sysfs Interface	Description	Support status	Notes
/sys/class/pwm/pwmchip0/device/gpt_operation_available	Show all available GPT operation	Yes	This config is read-only.
/sys/class/pwm/pwmchip0/device/gpt_operation	Sets GPT operation	Yes	Setting GPT operation before setting others config. (*1)
period	Sets the GPT signal period in nanoseconds	Yes	Need to set over 30. (*2)
duty_cycle	Sets the GPT signal duty cycle in nanoseconds.	Yes	Need to set period, before it is set. (*3) Need to set over 30. (*2)
enable	Enable/ disable the GPT signal.	Yes	Set period and duty_cycle, before it is set 1.
polarity	Invert output signal	Yes	echo normal > /sys/class/pwm/pwmchip0/pwm0/polarity change polarity to high end low when compare match. echo inverse > /sys/class/pwm/pwmchip0/pwm0/polarity change polarity to low end high when compare match.
capture	Capture pulse	Yes	cat /sys/class/pwm/pwmchip0/pwm0/capture and then generate pulse to input pin to capture
/sys/class/pwm/pwmchip0/device/buffA0 /sys/class/pwm/pwmchip0/device/buffB0	Set first buffer value in single buffer operation mode. Set first buffer value in double buffer operation mode.	Yes	Must set period before set buffer (*3) (*4) buffA0 set for channel A. buffB0 set for channel B.
/sys/class/pwm/pwmchip0/device/buffA1 /sys/class/pwm/pwmchip0/device/buffB1	Set second buffer value in single buffer operation mode. Set second buffer value in double buffer operation mode.	Yes	Must set period before set buffer (*3) (*4) buffA1 set for channel A. buffB1 set for channel B.
/sys/class/pwm/pwmchip0/device/buffA2 /sys/class/pwm/pwmchip0/device/buffB2	Set third buffer value in double buffer operation mode	Yes	Must set period before set buffer (*3) (*4) buffA2 set for channel A. buffB2 set for channel B.



/sys/class/pwm/pwmchip0/device/deadtime_first	Set first half dead time	Yes	(*5)
/sys/class/pwm/pwmchip0/device/deadtime_second	Set second half dead time	Yes	(*5)
/sys/class/pwm/pwmchip0/device/polarityA /sys/class/pwm/pwmchip0/device/polarityB	Set polarity and idle state	Yes	Set polarity and idle state for channel A and channel B.
/sys/class/pwm/pwmchip0/device/pulse_number	Set output pulse number	Yes	Set number of GPT output pulse.
/sys/bus/iio/devices/iio\:device0/in_count_counter_mode_available	Show all available mode count for counting input operation	Yes	This config is read-only.
/sys/bus/iio/devices/iio\:device0/in_count0_counter_mode	Set counter mode	Yes	See hardware manual for more detail in each counter mode
/sys/bus/iio/devices/iio\:device0/in_count0_counter_preset	Set max counter value	Yes	Counter will operate in range 0 -> in_count0_counter_preset
/sys/bus/iio/devices/iio\:device0/in_count0_raw	Current value of counter	Yes	
/sys/bus/iio/devices/iio\:device0/in_count0_en	Enable counter	Yes	Enable before count

Note:

\*1) Setting GPT operation first to use GPT, GPT has 6 operation, **default value** is normal\_output:

normal\_output, single\_buffer\_output, double\_buffer\_output, deadtime\_output, input\_capture, counting\_input.

- normal\_output: When the counter value matches the value set in duty cycle, the output from the associated pin GTIOCA or GTIOCB can be changed.
- single\_buffer\_output: the buffer transfer is performed at an overflow (when counter reach period setting).  
Ex: buffA1 will transfer to duty cycle buffA0, buffA0 will transfer to buffA1 => buffA0, buffA1 will become duty cycle sequentially.  
When the counter value matches the current value in duty cycle, the output from the associated pin GTIOCA or GTIOCB can be changed.
- double\_buffer\_output: the buffer transfer is performed at an overflow (when counter reach period setting).  
Ex: buffA2 will transfer to buffA1, buffA1 will transfer to duty cycle buffA0, buffA0 will transfer to buffA2 => buffA0, buffA1, buffA2 will become duty cycle sequentially.

When the counter value matches the current value in duty cycle, the output from the associated pin GTIOCA or GTIOCB can be changed.

- `deadtime_output`: This operation make channel A and channel B can not change at the same time, user can set time between channel A changing and channel B changing (deadtime)
- `input_capture`: This operation measure duty and period of input pulse
- `counting_input`: This operation uses GPT timer as a counter that count base on input pulse. Usually use for counting encoder.

Ex:

```
echo counting_input > /sys/class/pwm/pwmchip0/device/gpt_operation
```

\*2) The value of period and `duty_cycle` have some errors due to round up between calculations, we should set over this value to reduce effect of error calculation ( $\pm 1$  tick in register equivalent  $\pm 10$ ns).

\*3) When setting period, driver calculate prescale for GPT clock and detect frequency operating range for GPT module. `Duty_cycle`, buffer 0 and buffer 1 based on this range and cannot set prescale by itself.

\*4) Must set greater than 1000ns because if not do that, next buffer value will not affect immediately, it will affect after a few cycles.

Must set buffer in order period -> buff0 -> buff1....

Ex:

```
echo 50000000 > /sys/class/pwm/pwmchip0/pwm0/period
```

```
echo 20000000 > /sys/class/pwm/pwmchip0/device/buff0
```

```
echo 40000000 > /sys/class/pwm/pwmchip0/device/buff1
```

\*5) In this mode buffA1 is first half compare match and buffA2 is second half compare match

When switch in/out this mode, you should stop pwm to prevent unexpected output

Channel B is set automatically, you can read that value via `cat /sys/class/pwm/pwmchip0/device/buffB0`

Example using dead time mode:

```
echo deadtime_output > /sys/class/pwm/pwmchip0/device/gpt_operation (Enable dead time mode)
```

```
echo 50000 > /sys/class/pwm/pwmchip0/pwm0/period (Set period)
```

```
echo 15000 > /sys/class/pwm/pwmchip0/device/buffA1 (Set first half compare match)
```

```
echo 35000 > /sys/class/pwm/pwmchip0/device/buffA2 (Set second half compare match)
```

```
echo 5000 > /sys/class/pwm/pwmchip0/device/deadtime_first (Set dead time for first half)
```

```
echo 3000 > /sys/class/pwm/pwmchip0/device/deadtime_second (Set dead time for second half)
```

**Table 4.4 POEG sysfs device file**

POEG Sysfs Interface	Description	Support status	Notes
/sys/class/pwm/pwmchip0/device/POEG_available	Show all available POEG can be used	Yes	This config is read-only (*1)
/sys/class/pwm/pwmchip0/device/POEG	Set which POEG to use	Yes	Ex: echo POEGA > /sys/class/pwm/pwmchip0/device/POEG (*2)
/sys/devices/platform/soc/10048800.poeга/output_disable	Disable GPT output via software	Yes	Echo 1 > /sys/devices/platform/soc/10048800.poeга/output_disable disable GPT output Echo 0 > /sys/devices/platform/soc/10048800.poeга/output_disable enable GPT output
/sys/devices/platform/soc/10048c00.poeгb/output_disable	Disable GPT output via software	Yes	Echo 1 > /sys/devices/platform/soc/10048c00.poeгb/output_disable disable GPT output Echo 0 > /sys/devices/platform/soc/10048c00.poeгb/output_disable enable GPT output
/sys/devices/platform/soc/10049000.poeгc/output_disable	Disable GPT output via software	Yes	Echo 1 > /sys/devices/platform/soc/10049000.poeгc/output_disable disable GPT output Echo 0 > /sys/devices/platform/soc/10049000.poeгc/output_disable enable GPT output
/sys/devices/platform/soc/10049400.poeгd/output_disable	Disable GPT output via software	Yes	Echo 1 > /sys/devices/platform/soc/10049400.poeгd/output_disable disable GPT output Echo 0 > /sys/devices/platform/soc/10049400.poeгd/output_disable enable GPT output
/sys/bus/iio/devices/iio\:device0/in_count_reset_counter_available	Show all available reset counter can be used	Yes	This config is read-only (*3)
/sys/bus/iio/devices/iio\:device0/in_count0_reset_counter	Set which pin to use as reset counter	Yes	Ex: echo GTETRGA > /sys/bus/iio/devices/iio\:device0/in_count0_reset_counter (*4)

Note:

\*1) POEG now can be choose to use or not via sysfs.

User can check which POEG can be used by enter command:

```
dmesg | grep poeg
```

```
dmesg | grep gpt
```

Output as below: (In below picture poega, poegb, poegc, poegd can be used)

```

root@smarc-rzv2l:~# dmesg | grep poeg
[ 0.201992] poeg-rzg2l 10048800.poega: RZ/G2L POEG Driver probed
[ 0.202307] poeg-rzg2l 10048c00.poegb: RZ/G2L POEG Driver probed
[ 0.202584] poeg-rzg2l 10049000.poegc: RZ/G2L POEG Driver probed
[ 0.202860] poeg-rzg2l 10049400.poegd: RZ/G2L POEG Driver probed
root@smarc-rzv2l:~# dmesg | grep gpt
[ 0.200712] gpt-rzg2l 10048400.gpt: Can use GTETRGA as POEG, reset_counter
[ 0.200755] gpt-rzg2l 10048400.gpt: Can use GTETRGA as POEG, reset_counter
[ 0.200775] gpt-rzg2l 10048400.gpt: Can use GTETRC as POEG, reset_counter
[ 0.200795] gpt-rzg2l 10048400.gpt: Can use GTETRGD as POEG, reset_counter

```

Or can be checked by command: `cat /sys/class/pwm/pwmchip0/device/POEG_available`

POEG has 3 function:

1. Disable output via software:

Control via `/sys/devices/platform/soc/10048800.poega/output_disable` if POEGA is chosen

Control via `/sys/devices/platform/soc/10048c00.poegb/output_disable` if POEGB is chosen

Control via `/sys/devices/platform/soc/10049000.poegc/output_disable` if POEGC is chosen

Control via `/sys/devices/platform/soc/10049400.poegd/output_disable` if POEGD is chosen

Note: Currently G3E only support this mode.

2. Disable output via input level detection:

When input pin of POEG receive high level signal, GPT output is disabled

But RZG2L Evaluation Board Kit **don't have pin** for this function.

3. Disable output request from GPT (this mode only work in when GPT in double output mode):

When 2 output pin of GPT have the same level, GPT output is disabled

In dead time mode, POEG not disable output have the same output logic signal, it only disable when there is deadtime error

\*2) If user don't want to use POEG:

`echo NOT_USE > /sys/class/pwm/pwmchip0/device/POEG`

\*3) reset counter is used for clear counter when GPT operate in counting input operation

This input pin is using the same POEG pin.

User can check which reset counter pin can be used by command:

`cat /sys/bus/iio/devices/iio\:device0/in_count_reset_counter_available`

(In below picture poega, poegb, poegc, poegd pin can be used as reset counter)

```

root@smarc-rzv2l:~# cat /sys/bus/iio/devices/iio\:device1/in_count_reset_counter
_available
NOT_USE GTETRGA GTETRGA GTETRC GTETRGD

```

\*4) If user don't want to use reset counter:

`echo NOT_USE > /sys/bus/iio/devices/iio\:device0/in_count0_reset_counter`

## 5. Integration

### 5.1 Directory Configuration

The directory configuration is shown below.

—— drivers/pwm	—— gpt-rzg2l.c	: GPT timer driver source file
	—— poeg-rzg2l.c	: POEG driver source file

**Figure 5-1 Directory configuration**

### 5.2 Integration Procedure

#### 5.2.1 Choosing output channel

The following description explains how to choose GPT output channel in RZ/G2L and RZ/V2L.

The following description indicates a difference from the default setting. ("−": Delete a description (default setting), "+": Setting after the modification))

file: arch/arm64/boot/dts/renesas/rzg2l-smarc-som.dtsi for RZG2L and arch/arm64/boot/dts/renesas/rzg2l-smarc.dtsi for RZG2LC

```
&gpt4 {
    pinctrl-0 = <&gpt4_pins>;
    pinctrl-names = "default";
+   channel = "channel_A";
    status = "okay";
};
```

**Figure 5-2 Choosing output channel (RZ/G2L)**

file: arch/arm64/boot/dts/renesas/rzg3e-smarc.dtsi for RZ/G3E

```
#if (I2C1_GPT_SEL)
&gpt0_1 {
    pinctrl-0 = <&gpt0_1_pins>;
    pinctrl-names = "default";
    channel = "both_AB";
    poeg = <&poega>;
    status = "okay";
};
```

**Figure 5-3 Choosing output channel (RZ/G3E)**

Note\*: Hardware design of GPT0\_1 for RZ/G3E interface have some pins function control conflict with others function. Define switch macro to choose GPT0\_1 function for pins (arch/arm64/boot/dts/renesas/r9a09g047e57-smarc.dts)

```
/*
 * I2C1 and GPT (PMOD) selection
 * 0 - I2C1
 * 1 - GPT0_1 on PMOD0
 */
#define I2C1_GPT_SEL 0
```

**Figure 5-4 Define macro switch for GPT0\_1 (RZ/G3E)**

- In single output mode, GPT on boards only output **one** pin port so you must choose which channel corresponding to that pin (channel A or channel B).

Ex: For RZG2L Evaluation Board Kit, choose channel A as below:

```
channel = "channel_A";
```

For choosing channel B:

```
channel = "channel_B";
```

- In double output mode, GPT on boards output **two** pin port. Choose this mode as below:  
channel = "both\_AB";
- Remember to choose 2 correspond pin in pinctrl-0 when using double output mode.
- Remember when using GPT as backlight, setting channel = "channel\_A" or channel = "channel\_B" because in "both\_AB" mode, must set duty cycle of gpt via /sys/class/pwm/pwmchip0/device/buffA0 or /sys/class/pwm/pwmchip0/device/buffB0, but in backlight driver it set duty cycle via /sys/class/pwm/pwmchip0/pwm0/duty\_cycle.

### 5.2.2 Choosing POEG group

The following description explains how to choose POEG group in RZ/G2L, RZ/V2L and RZ/G3E.

The following description indicates a difference from the default setting. ("-": Delete a description (default setting), "+": Setting after the modification))

file: arch/arm64/boot/dts/renesas/rzg2l-smarc-som.dtsi for RZG2L, arch/arm64/boot/dts/renesas/rzg2l-smarc.dtsi for RZG2LC and arch/arm64/boot/dts/renesas/rzg3e-smarc.dtsi for RZ/G3E.

```

+&poega {
+    status = "okay";
+};

+&poegb {
+    status = "okay";
+};

+&poegc {
+    status = "okay";
+};

+&poegd {
+    status = "okay";
+};

&gpt4 {
    pinctrl-0 = <&gpt4_pins>;
    pinctrl-names = "default";
    channel = "channel_A";
+    poeg = <&poega &poegb &poegc &poegd >;
    status = "okay";
};

```

Figure 5-5 Choosing POEG group (RZ/G2L)

file: arch/arm64/boot/dts/renesas/rzg3c-smarc.dtsi for RZ/G3E

```

#if (I2C1_GPT_SEL)
&gpt0_1 {
    pinctrl-0 = <&gpt0_1_pins>;
    pinctrl-names = "default";
    channel = "both_AB";
    poeg = <&poega>;
    status = "okay";
};

&poega {
    pinctrl-0 = <&poega_pins>;
    pinctrl-names = "default";
    status = "okay";
};

#endif

```

Figure 5-6 Choosing POEG group (RZ/G3E)

There is 4 type of poeg : poega, poegb, poegc, poegd user can chose which POEG, reset counter to use via sysfs.

- Always set poeg = <&poega &poegb &poegc &poegd > in gpt node , if don't want use what poeg, set status = "disabled" in that poeg node.
- For RZG2L Evaluation Board Kit, there is no input pin for poeg, so user can add as Figure 5.2
- For RZG2L Evaluation Board Kit, for easier using, user can enable poeg by set POEGD\_SUPPORT to 1 in arch/arm64/boot/dts/renesas/rzg2l-smarc.dtsi
- For RZG3E SMARC Evaluation Board Kit, there is no input pin for poeg, so user can add as Figure 5.6.

### 5.2.3 Kernel Configuration

To enable the function of this module, make the following setting with Kernel Configuration.

```
Device Drivers --->
  [*] Pulse-Width Modulation (PWM) Support ----
    <*> GPT RZG2L
    <*> POEG RZG2L
```

**Figure 5-7 Kernel configuration**

## 5.3 Device Tree Setting

### 5.3.1 GPT node

Basic configuration information of GPT is defined at device tree file (r9a07g044.dtsi for RZ/G2L, r9a07054.dtsi for RZ/V2L and r9a09g047.dtsi for RZ/G3E). It exists at arch/arm64/boot/dts/renesas directory. This module uses these described contents in device tree file.

The initial reference information is shown below.



```

gpt4: gpt@10048400 {
    compatible = "renesas,gpt-r9a07g044";
    reg = <0 0x10048400 0 0xa4>;
    #pwm-cells = <2>;
    interrupts = <GIC_SPI 270 IRQ_TYPE_EDGE_RISING>,
        <GIC_SPI 271 IRQ_TYPE_EDGE_RISING>,
        <GIC_SPI 272 IRQ_TYPE_EDGE_RISING>,
        <GIC_SPI 273 IRQ_TYPE_EDGE_RISING>,
        <GIC_SPI 274 IRQ_TYPE_EDGE_RISING>,
        <GIC_SPI 275 IRQ_TYPE_EDGE_RISING>,
        <GIC_SPI 276 IRQ_TYPE_EDGE_RISING>,
        <GIC_SPI 277 IRQ_TYPE_EDGE_RISING>,
        <GIC_SPI 278 IRQ_TYPE_EDGE_RISING>,
        <GIC_SPI 279 IRQ_TYPE_EDGE_RISING>,
        <GIC_SPI 280 IRQ_TYPE_EDGE_RISING>,
        <GIC_SPI 281 IRQ_TYPE_EDGE_RISING>,
        <GIC_SPI 282 IRQ_TYPE_EDGE_RISING>;
    interrupt-names = "gtcia", "gtcib", "gtcic", "gtcid",
        "gtcie", "gtcif", "gtciada", "gtciadb",
        "gtciv", "gtciu", "gtcih", "gtcil",
        "gtdei";
    clocks = <&cpg CPG_MOD R9A07G044_GPT_PCLK>;
    power-domains = <&cpg>;
    resets = <&cpg R9A07G044_GPT_RST_C>;
    status = "disabled";
};

```

**Figure 5-8 Device tree initial references information of GPT (RZ/G2L and RZ/V2L)**

Note: All of the information in above device tree is used for both RZ/G2L and RZ/V2L except clocks and resets.

Required properties:

- **compatible:**  
must be "renesas,gpt-r9a07g044" for R9A07G044 (RZ/G2L) and "renesas,gpt-r9a07g054" for R9A07G054 (RZ/V2L).
- **reg:**  
need two resources, first one mapped to register base address, second one mapped to extension resource registers base address.
- **interrupts:**  
interrupt specifier for the GPT
- **interrupt-names:**  
mapped with interrupts and must be in the order with interrupts number.
- **clocks:** R9A07G044\_GPT\_PCLK is used for RZ/G2L and R9A07G054\_GPT\_PCLK is used for RZ/V2L.
- **reset:** R9A07G044\_GPT\_RST\_C is used for RZ/G2L and R9A07G054\_GPT\_RST\_C is used for RZ/V2L  
phandle + clock/reset specifier pairs

```

gpt0_1: gpt@13010100 {
    compatible = "renesas,gpt-r9a09g047";
    reg = <0 0x13010100 0 0xa4>;
    #pwm-cells = <2>;
    interrupts = <GIC_SPI 539 IRQ_TYPE_EDGE_RISING>,
                <GIC_SPI 547 IRQ_TYPE_EDGE_RISING>,
                <GIC_SPI 555 IRQ_TYPE_EDGE_RISING>,
                <GIC_SPI 563 IRQ_TYPE_EDGE_RISING>,
                <GIC_SPI 571 IRQ_TYPE_EDGE_RISING>,
                <GIC_SPI 579 IRQ_TYPE_EDGE_RISING>,
                <GIC_SPI 587 IRQ_TYPE_EDGE_RISING>,
                <GIC_SPI 595 IRQ_TYPE_EDGE_RISING>;
    interrupt-names =
        "gtcia", "gtcib", "gtcic", "gtcid",
        "gtcie", "gtcif", "gtcih", "gtcil";
    clocks = <&cpg CPG_MOD 49>;
    power-domains = <&cpg>;
    resets = <&cpg 89>,
            <&cpg 90>;
    status = "disabled";
};

```

**Figure 5-9 Device tree initial references information of GPT (RZ/G3E)**

Note: All of the information in above device tree is used for RZ/G3E.

Required properties:

- compatible:  
must be "renesas,gpt-r9a09g047" for R9A09G047 (RZ/G3E)
- reg:  
need two resources, first one mapped to register base address, second one mapped to extension resource registers base address.
- interrupts:  
interrupt specifier for the GPT
- interrupt-names:  
mapped with interrupts and must be in the order with interrupts number.
- clocks: GPT\_PCLK\_SFR index 49 is used for RZ/G3E

- reset: GPT0\_RST\_P\_REG index 89 is used for RZ/G3E
- reset: GPT0\_RST\_S\_REG index 90 is used for RZ/G3E  
phandle + clock/reset specifier pairs

### 5.3.2 POEG node

Basic configuration information of GPT is defined at device tree file (r9a07g044.dtsi for RZ/G2L, r9a07054.dtsi for RZ/V2L and r9a09g047.dtsi for RZ/G3E). It exists at arch/arm64/boot/dts/renesas directory. This module uses these described contents in device tree file.

The initial reference information is shown below.

```

poegd: poegd@10049400 {
    compatible = "renesas,poeg-r9a07g044";
    reg = <0 0x10049400 0 0x04>;
    interrupts = <GIC_SPI 325 IRQ_TYPE_LEVEL_HIGH>;
    clocks = <&cpg CPG_MOD R9A07G044_POEG_D_CLKP>;
    power-domains = <&cpg>;
    resets = <&cpg R9A07G044_POEG_D_RST>;
    status = "disabled";
};

```

**Figure 5-10 Device tree initial references information of POEG (RZ/G2L)**

Note: All of the information in above device tree is used for both RZ/G2L and RZ/V2L except clocks and resets.

Required properties:

- compatible:  
must be "renesas,poeg-r9a07g044" for R9A07G044 (RZ/G2L) and "renesas,poeg-r9a07g054" for R9A07G054 (RZ/V2L).
- reg:  
need two resources, first one mapped to register base address, second one mapped to extension resource registers base address.
- interrupts:  
interrupt specifier for the GPT
- interrupt-names:  
mapped with interrupts and must be in the order with interrupts number.
- clocks: R9A07G044\_POEG\_D\_CLKP is used for RZ/G2L and R9A07G054\_POEG\_D\_CLKP is used for RZ/V2L.
- reset: R9A07G044\_POEG\_D\_RST is used for RZ/G2L and R9A07G054\_POEG\_D\_RST is used for RZ/V2L  
phandle + clock/reset specifier pairs

```

poega: poega@13001C00 {
    compatible = "renesas,poeg-r9a09g047";
    reg = <0 0x13001C00 0 0x04>;
    interrupts = <GIC_SPI 666 IRQ_TYPE_LEVEL_HIGH>;
    clocks = <&cpg CPG_MOD 51>;
    power-domains = <&cpg>;
    resets = <&cpg 93>;
    status = "disabled";
};

```

**Figure 5-11 Device tree initial references information of POEG (RZ/G3E)**

Note: All of the information in above device tree is used for RZ/G3E.

Required properties:

- compatible:  
must be "renesas,poeg-r9a09g047" for R9A09G047 (RZ/G3E)
- reg:  
need two resources, first one mapped to register base address, second one mapped to extension resource registers base address.
- interrupts:  
interrupt specifier for the GPT
- interrupt-names:  
mapped with interrupts and must be in the order with interrupts number.
- clocks: R9A07G044\_POEG\_A\_CLKP index 51 is used for RZ/G3E.
- reset: R9A07G044\_POEG\_A\_RST index 93 is used for RZ/G3E.  
phandle + clock/reset specifier pairs

### 5.3.3 Documentation file in the kernel

Please follow guideline in Documentation/devicetree/bindings/pwm/pwm.txt

Please follow guideline in Documentation/devicetree/bindings/pwm/renesas,poeg-rzg2l.txt

## 5.4 Option Setting

### 5.4.1 Module Parameters

There are no module parameters.

### 5.4.2 Kernel Parameters

There are no parameters.

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Rev.	Date	Description	
		Page	Summary
0.50	Apr. 30, 2021	—	First Edition issued
1.0	Jul. 15, 2021	—	No modification, keep version to keep consistent with other documents
1.1	Sep. 15, 2021	—	Merge RZ/G2L driver manual with RZ/V2L
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